L Number	Hits	Search Text	DB	Time stamp
-	206	(349/44).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/23 08:47
-	9	((349/44).CCLS.) and (side adj2 shield)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/08 14:58
-	2	("6518081").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/23 08:52
-	34086	("349").CLAS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/23 09:28
-	0	(("349").CLAS.) and (side adj2 shield adj2 TFT)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/23 09:28
-	73	(("349").CLAS.) and (side adj2 shield)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/23 09:28
-	53	((("349").CLAS.) and (side adj2 shield)) and TFT	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/08 15:01
-	20	(((("349").CLAS.) and (side adj2 shield)) and TFT) and (capacit$4 adj2 electrode)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/23 09:33
-	188	(("349").CLAS.) and (side adj2 black)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/23 09:33
-	2	((("349").CLAS.) and (side adj2 black)) and (black adj2 TFT)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/23 09:42
-	2350	(257/59,72).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/23 09:42
-	1576	((257/59,72).CCLS.) and TFT	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/23 09:42
-	15	(((257/59,72).CCLS.) and TFT) and (TFT adj2 shield)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/23 09:50

-	6	(((257/59,72).CCLS.) and TFT) and (side adj2 shield)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/23 09:50
-	2	("6518081").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/08 14:41
-	2	("2002200578").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/08 14:41
-	2	("20040008295").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/08 14:44
-	8	((349/44).CCLS.) and (side adj2 shield) and contact	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/08 14:58
-	0	((("349").CLAS.) and (side adj2 shield)) and TFT and (contact adj2 shield)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/08 15:02
-	9	((("349").CLAS.) and (side adj2 shield)) and TFT and (contact adj4 shield)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/08 15:05
-	0	((("349").CLAS.) and (side adj2 shield)) and (TFT adj3 enclos$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/08 15:05
-	0	((("349").CLAS.) and (side adj2 shield)) and (TFT adj3 box)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/08 15:05
-	1	((("349").CLAS.) and (side adj2 shield)) and (TFT near cover)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/08 15:09
-	715	(438/30).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/08 15:09
-	2	((438/30).CCLS.) and (side adj2 shield)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/08 15:11
-	10	((438/30).CCLS.) and (TFT adj4 cover)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/08 15:19

-	5	((438/30).CCLS.) and (bottom adj2 shield)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/08 15:24
-	34205	("349").CLAS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/08 15:24
-	22	(("349").CLAS.) and (bottom adj2 shield)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/08 15:25
-	37	shield adj4 silicide	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/09 11:45
-	31	(shield adj4 silicide) and silicon	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/09 11:41
-	3225614	shield adj4 two layer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/09 11:46
-	327	shield adj4 two adj2 layer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/09 11:47
-	0	(shield adj4 two adj2 layer) and (silicide adj4 silicon)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/09 11:47
-	0	(shield adj4 two adj2 layer) and (metal adj4 silicon)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/09 11:48
-	6	(shield adj4 two adj2 layer) and (silicide)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/09 13:48
-	115807	349/	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/09 13:49
-	1017	349/ and CMP	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/09 13:49
-	407	(349/ and CMP) and (chemical adj2 polish$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/09 13:49

-	0	((349/ and CMP) and (chemical adj2 polish$4)) and (side adj2 shiled)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/09 13:51
-	169	((349/ and CMP) and (chemical adj2 polish$4)) and planariza$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/09 13:52
-	123	(((349/ and CMP) and (chemical adj2 polish$4)) and planariza$4) and insulat$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/09 13:52
-	0	(((349/ and CMP) and (chemical adj2 polish$4)) and planariza$4) and (insulat$4 adj2 planariza$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/09 13:52
-	8	(((349/ and CMP) and (chemical adj2 polish$4)) and planariza$4) and (insulat$4 near planariza$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/11/09 13:52